504527096 08/30/2017

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
YANMEI SUN	08/29/2017

### **RECEIVING PARTY DATA**

Name:	GOERTEK.INC	
Street Address:	NO. 268 DONGFANG ROAD, HI-TECH INDUSTRY DISTRICT	
City:	WEIFANG CITY, SHANDONG	
State/Country:	CHINA	
Postal Code:	261031	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15554653

#### **CORRESPONDENCE DATA**

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Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

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ATTORNEY DOCKET NUMBER:	131693.420498	
NAME OF SUBMITTER:	STEVEN J. SCHWARZ	
SIGNATURE:	//STEVEN J. SCHWARZ//	
DATE SIGNED:	08/30/2017	

**Total Attachments: 1** 

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PATENT 504527096 REEL: 043451 FRAME: 0845

## WORLDWIDE ASSIGNMENT

WHEREAS Yanmei SUN of Weifang City, Shandong, China, hereinafter (collectively) referred to as the Assignor, has invented a certain improvement relating to INTEGRATED STRUCTURE OF MEMS MICROPHONE AND PRESSURE SENSOR AND MANUFACTURING METHOD FOR THE INTEGRATED STRUCTURE, which said Assignor has caused an application for United States Letters Patent to be prepared,

[x] the inventor's declaration for said application being executed concurrently with the execution of this instrument: said application to be filed in the United States Patent and Trademark Office;

[x] said application having been filed in the United States Patent and Trademark Office on \_\_\_\_\_\_\_\_\_, Serial Number \_\_\_\_\_\_\_\_;

[x] said application having been filed under the Patent Cooperation Treaty on <u>December 14, 2015</u>, and given International Application No. <u>PCT/CN2015/097315</u>, the United States of America having been designated:

WHEREAS Goertek Inc having an address of No. 268 Dongfang Road, Hi-Tech Industry District, Weifang City, Shandong 261031 CHINA hereinafter referred to as the Assignee, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefore, including any and all renewals, reissues and prolongations thereof;

NOW THIS WITNESSETH, that for and in consideration of One Dollar (\$1.00), and other good and valuable consideration paid by Assignee to Assignor, the receipt and sufficiency of which is hereby acknowledged, Assignor hereby assigns, sells and transfers, and has assigned, sold, and transferred to Assignee, its successors and assigns, the entire and exclusive right, title, and interest for the United States in and to the invention, the application, and any patents which may be granted therefor, including any and all divisions, continuations, in whole or in part, substitutions, renewals, reissues, reexaminations, and extensions thereof, and all applications claiming priority therefrom; and Assignor authorizes and requests the Commissioner of Patents and Trademarks to issue all patents for the invention, or patents resulting therefrom, insofar as their interest is concerned, to Assignee; to have, hold, exercise, and enjoy, with all the rights, powers, privileges, and advantages in anywise arising therefrom or appertaining thereto, for and during the term or terms of any and all such patents when granted, for the use and benefit of said Assignee, and said Assignee's successors and assigns, in as ample and beneficial a manner as Assignor might or could have held and enjoyed the same, if this assignment had not been made.

Assignor further hereby assigns, sells and transfers, and has assigned, sold, and transferred to Assignee, its successors and assigns, the entire right, title and interest in all countries of the world, in and to the invention and in and to the application and all patents which may be granted therefor, and all national applications, regional applications, divisions, reissues, substitutions, continuations, in whole or in part, re-examinations, and extensions thereof, including the right to file applications and obtain patents for the invention in its own name, in all countries and including all rights of priority in all countries under the terms of any applicable international convention, insofar as its interest is concerned; and the Assignor hereby authorizes and requests the applicable patent office in each country of the world to issue all patents for the invention, or patents resulting therefrom, insofar as its interest is concerned, to the Assignee, to have and to hold for the sole and exclusive use and benefit of the Assignee, its successors and assigns, to the full end of the term or terms for which any and all of such patents for the invention may issue, to the same extent as the Assignor would hold and enjoy if this Assignment had not been made.

The Assignor further agrees to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights, and also agrees, at the request of the Assignee, to testify in any legal proceedings, sign all lawful papers, make all lawful oaths, and generally do everything possible to aid said Assignee, its successors and assigns, to obtain, maintain and enforce proper patent protection for said invention.

IN WITNESS WHEREOF, each individual collectively referred to as Assignor has caused this Assignment to be executed.

EXECUTED this 29 day of August . 2017	1.
ASSIGNOR: Yanmei SUN	WITNESS:
Signature: Your Mei SUN	Signature:Name:Address:

PATENT

Attorney Docket No.: 131693,420498

RECORDED: 08/30/2017 REEL: 043451 FRAME: 0846